- **State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation**
- **I_{off} and Power-Up 3-State Support Hot Insertion**
- **Bus-Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors**
- **Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})**
- **Support Unregulated Battery Operation Down to 2.7 V**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C**
- **Latch-Up Performance Exceeds 500 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), and Thin Very Small-Outline (DGV) Packages, Ceramic Chip Carriers (FK), and Ceramic (JT) DIPs**

SN54LVTH2952 . . . JT PACKAGE
SN74LVTH2952 . . . DB, DGV, DW, OR PW PACKAGE
(TOP VIEW)

B8	1	24 V_{CC}
B7	2	23 A8
B6	3	22 A7
B5	4	21 A6
B4	5	20 A5
B3	6	19 A4
B2	7	18 A3
B1	8	17 A2
OEAB	9	16 A1
CLKAB	10	15 OEBA
CLKENAB	11	14 CLKBA
GND	12	13 CLKENBA

SN54LVTH2952 . . . FK PACKAGE
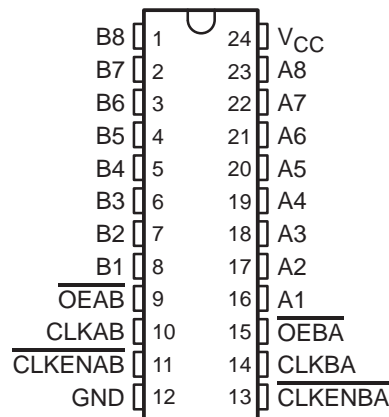(TOP VIEW)

NC – No internal connection

description

These octal bus transceivers and registers are designed specifically for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

The 'LVTH2952 devices consist of two 8-bit back-to-back registers that store data flowing in both directions between two bidirectional buses. Data on the A or B bus is stored in the registers on the low-to-high transition of the clock (CLKAB or CLKBA) input, provided that the clock-enable (CLKENAB or CLKENBA) input is low. Taking the output-enable (OEAB or OEBA) input low accesses the data on either port.
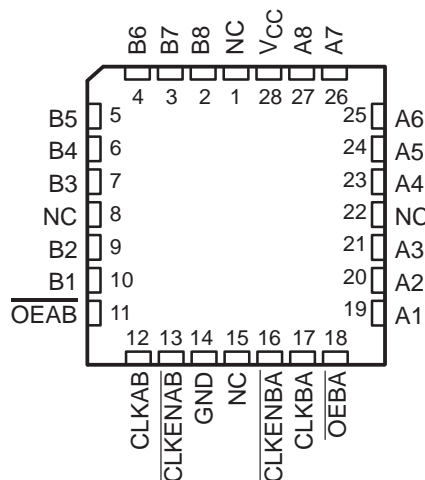
Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When V_{CC} is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

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description (continued)

These devices are fully specified for hot-insertion applications using I_{off} and power-up 3-state. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

The SN54LVTH2952 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LVTH2952 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE[†]

INPUTS				OUTPUT
CLKENAB	CLKAB	OEAB	A	B
H	X	L	X	B_0[‡]
X	H or L	L	X	B_0[‡]
L	↑	L	L	L
L	↑	L	H	H
X	X	H	X	Z

[†] A-to-B data flow is shown; B-to-A data flow is similar but uses CLKENBA, CLKBA, and OEBA.

[‡] Level of B before the indicated steady-state input conditions were established

logic symbol[§]
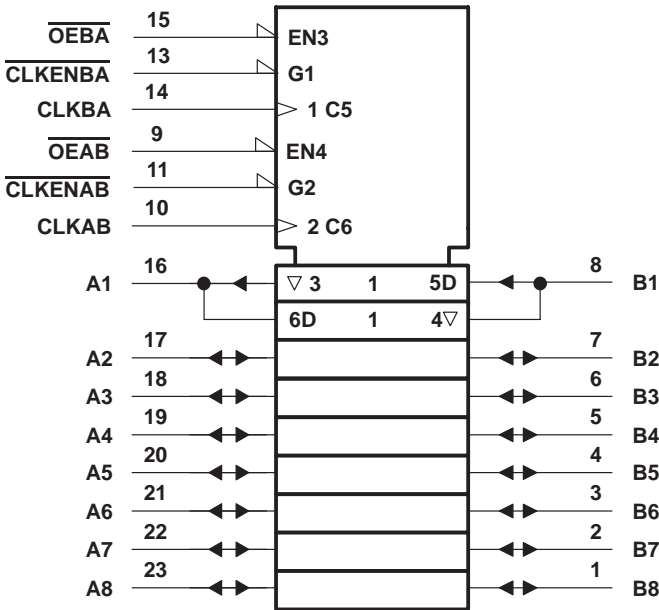
[§] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the DB, DGV, DW, JT, and PW packages.

logic diagram (positive logic)

To Seven Other Channels

Pin numbers shown are for the DB, DGV, DW, JT, and PW packages.
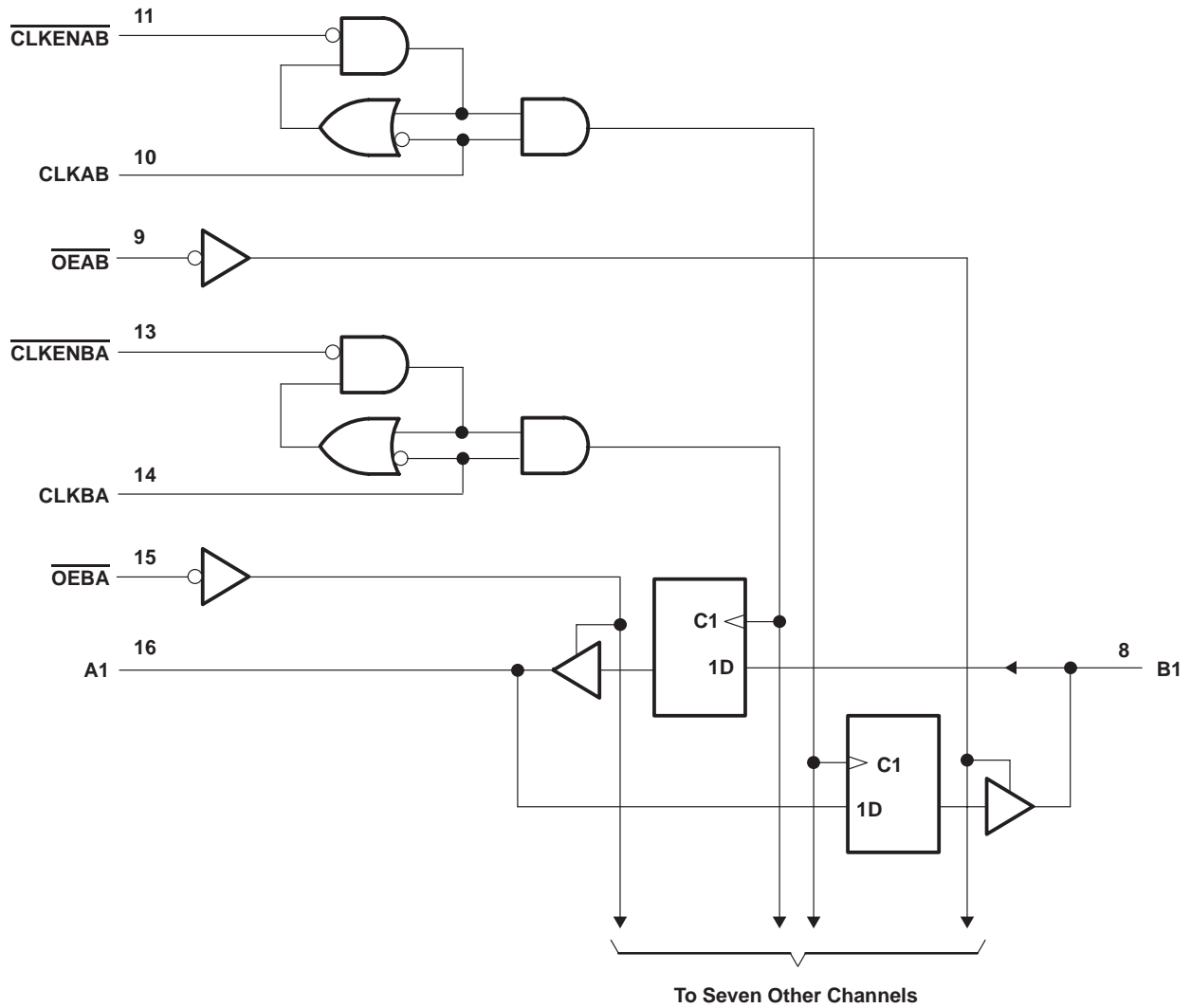
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} .... –0.5 V to 4.6 V
Input voltage range, V_I (see Note 1) .... –0.5 V to 7 V
Voltage range applied to any output in the high-impedance
  or power-off state, V_O (see Note 1) .... –0.5 V to 7 V
Voltage range applied to any output in the high state, V_O (see Note 1) .... –0.5 V to V_{CC} + 0.5 V
Current into any output in the low state, I_O: SN54LVTH2952 .... 96 mA
                                                SN74LVTH2952 .... 128 mA
Current into any output in the high state, I_O (see Note 2): SN54LVTH2952 .... 48 mA
                                                              SN74LVTH2952 .... 64 mA
Input clamp current, I_{IK} ($V_I < 0$) .... –50 mA
Output clamp current, I_{OK} ($V_O < 0$) .... –50 mA
Package thermal impedance, θ_{JA} (see Note 3): DB package .... 104°C/W
                                                      DGV package .... 139°C/W
                                                      DW package .... 81°C/W
                                                      PW package .... 120°C/W
Storage temperature range, T_{stg} .... –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1.   The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
         2.   This current flows only when the output is in the high state and $V_O > V_{CC}$.
         3.   The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

		SN54LVTH2952		SN74LVTH2952		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2.7	3.6	2.7	3.6	V
V_{IH}	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
V_I	Input voltage		5.5		5.5	V
I_{OH}	High-level output current		–24		–32	mA
I_{OL}	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200		200		μs/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 4:   All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54LVTH2952 MIN	TYP†	MAX	SN74LVTH2952 MIN	TYP†	MAX	UNIT
V_{IK}		V_{CC} = 2.7 V,	I_I = −18 mA			−1.2			−1.2	V
V_{OH}		V_{CC} = 2.7 V to 3.6 V,	I_{OH} = −100 μA	V_{CC}−0.2			V_{CC}−0.2			V
		V_{CC} = 2.7 V,	I_{OH} = −8 mA	2.4			2.4			
		V_{CC} = 3 V	I_{OH} = −24 mA	2						
			I_{OH} = −32 mA				2			
V_{OL}		V_{CC} = 2.7 V	I_{OL} = 100 μA			0.2			0.2	V
			I_{OL} = 24 mA			0.5			0.5	
		V_{CC} = 3 V	I_{OL} = 16 mA			0.4			0.4	
			I_{OL} = 32 mA			0.5			0.5	
			I_{OL} = 48 mA			0.55				
			I_{OL} = 64 mA						0.55	
I_I	Control inputs	V_{CC} = 3.6 V,	V_I = V_{CC} or GND			±1			±1	μA
		V_{CC} = 0 or 3.6 V,	V_I = 5.5 V			10			10	
	A or B ports‡	V_{CC} = 3.6 V	V_I = 5.5 V			20			20	
			V_I = V_{CC}			1			1	
			V_I = 0			−5			−5	
I_{off}		V_{CC} = 0,	V_I or V_O = 0 to 4.5 V						±100	μA
$I_{I(hold)}$	A or B ports	V_{CC} = 3 V	V_I = 0.8 V	75			75			μA
			V_I = 2 V	−75			−75			
		V_{CC} = 3.6 V§,	V_I = 0 to 3.6 V						±500	
I_{OZPU}		V_{CC} = 0 to 1.5 V, V_O = 0.5 V to 3 V, $\overline{OE}$ = don't care				±100*			±100	μA
I_{OZPD}		V_{CC} = 1.5 V to 0, V_O = 0.5 V to 3 V, $\overline{OE}$ = don't care				±100*			±100	μA
I_{CC}		V_{CC} = 3.6 V, I_O = 0, V_I = V_{CC} or GND	Outputs high			0.19			0.19	mA
			Outputs low			5			5	
			Outputs disabled			0.19			0.19	
ΔI_{CC}¶		V_{CC} = 3 V to 3.6 V, One input at V_{CC} − 0.6 V, Other inputs at V_{CC} or GND				0.2			0.2	mA
C_i		V_I = 3 V or 0				4			4	pF
C_{io}		V_O = 3 V or 0				9			9	pF

∗ On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ Unused terminals at V_{CC} or GND

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirement over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

			SN54LVTH2952				SN74LVTH2952				UNIT
			$V_{CC} = 3.3$ V $\pm$ 0.3 V		$V_{CC} = 2.7$ V		$V_{CC} = 3.3$ V $\pm$ 0.3 V		$V_{CC} = 2.7$ V		
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency			150		150		150		150	MHz
t_w	Pulse duration	CLK high	3.3		3.3		3.3		3.3		ns
		CLK low	3.3		3.3		3.3		3.3		
t_{su}	Setup time	A or B before CLK↑ — Data high	1.6		2.2		1.5		2.1		ns
		A or B before CLK↑ — Data low	1.6		2.2		1.5		2.1		
		$\overline{CE}$ before CLK↑ — Data high	1.6		1.9		1.5		1.8		
		$\overline{CE}$ before CLK↑ — Data low	2		2.6		1.9		2.5		
t_h	Hold time	A or B after CLK↑	1		0.2		1		0.2		ns
		$\overline{CE}$ after CLK↑	1.2		0.2		1.2		0.2		

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

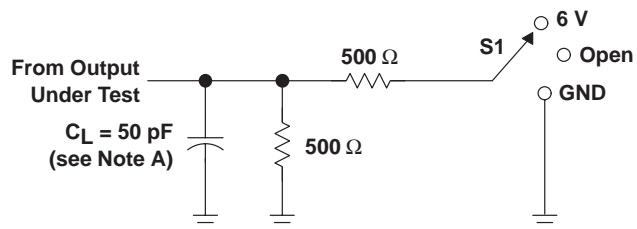| PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVTH2952				SN74LVTH2952					UNIT
			$V_{CC} = 3.3$ V $\pm$ 0.3 V		$V_{CC} = 2.7$ V		$V_{CC} = 3.3$ V $\pm$ 0.3 V			$V_{CC} = 2.7$ V		
			MIN	MAX	MIN	MAX	MIN	TYP†	MAX	MIN	MAX	
f_{max}			150		150		150			150		MHz
t_{PLH}	CLKBA or CLKAB	A or B	1.2	4.8		5.5	1.3	2.9	4.6		5.3	ns
t_{PHL}			1.2	4.8		5.5	1.3	3.1	4.6		5.3	
t_{PZH}	$\overline{OEBA}$ or $\overline{OEAB}$	A or B	1	4.8		5.9	1.1	2.6	4.6		5.8	ns
t_{PZL}			1	4.8		5.9	1.1	3	4.6		5.8	
t_{PHZ}	$\overline{OEBA}$ or $\overline{OEAB}$	A or B	1.2	5.6		6	1.3	3.6	5.4		5.9	ns
t_{PLZ}			1.5	5.4		5.6	1.6	3.6	5.1		5.3	

† All typical values are at $T_A = 25°C$.

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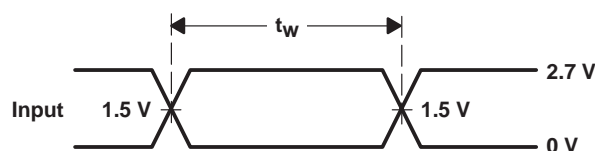
PARAMETER MEASUREMENT INFORMATION

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND

LOAD CIRCUIT FOR OUTPUTS
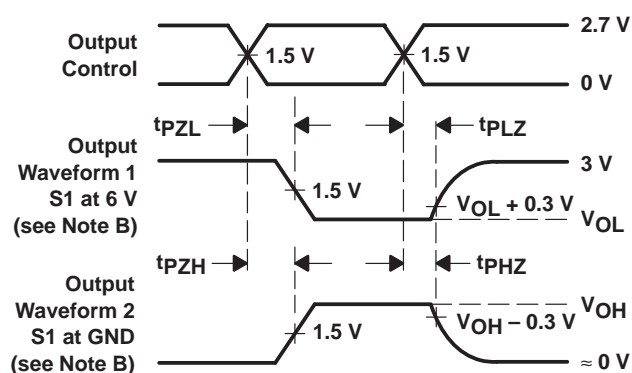
VOLTAGE WAVEFORMS
PULSE DURATION

VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES

VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
   B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
       Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
   D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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